

Structure Silicon Monolithic Integrated Circuit

Product Name Flash LED Driver for mobile phone with camera

Type **BD6062GU**

Features Flash(1A max.) and Torch(200mA max.) mode available for camera.
Flash time and current control by register (register control interface)

○Absolute Maximum Ratings (Ta= 25 °C)

Parameter	Symbol	Rating	Unit	Condition
Maximum applied voltage	VMAX	7	V	Maximum applied voltage
Input voltage	Vdin	GND-0.3 ~ VBAT+0.3	V	Input voltage
Power dissipation	Pd	1100 (Note1)	mW	Power dissipation
Operating temperature range	Topr	-30 ~ +85	°C	Operating temperature range
Storage temperature range	Tstg	-55 ~ +150	°C	Storage temperature range

(Note1) The measurement value which was mounted on the PCB by ROHM.
(50mm×58mm×1.75mm glass epoxy Board)
Temperature delecting : 11mW/°C from Ta>25°C

○Recommended operating conditions (Ta= -30 ~ 85 °C)

Parameter	Symbol	Rating			Unit	Condition
		Min.	Typ.	Max.		
Battery Power Supply voltage	VBAT	2.7	3.6	5.5	V	(Note2)
I/O Power Supply voltage	VIO	1.62	1.8	3.3	V	(Note2)

(Note2) VBAT VIO ≥

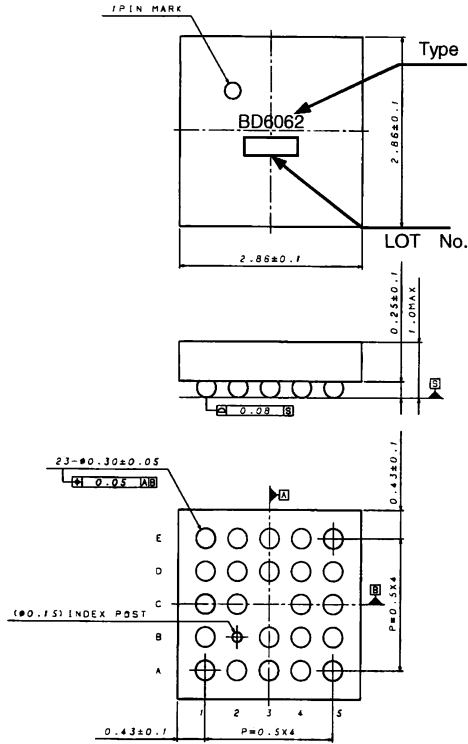
This product isn't designed to protect itself against radioactive rays.

○Electrical Characteristics

(Unless otherwise noted, Ta = +25°C, VBAT=3.6V, VIO=1.8V)

Parameter	Symbol	Spec			Unit	Condition
		Min.	Typ.	Max.		
Logic control terminal (IFMODE='L', 3wire control mode)						
Low threshold voltage1	VthL1	-	-	VIO x 0.25	V	
High threshold voltage1	VthH1	VIO x 0.75	-	-	V	
High level Input current	IinH1	-	-	5	μA	Vin=VIO
Low level Input current	IinL1	-5	-	-	μA	Vin=0V
Logic control terminal (IFMODE='H', 2wire control mode)						
Low threshold voltage	VthL2	-	-	0.4	V	
High threshold voltage	VthH2	1.4	-	-	V	
High level Input current	IinH2	-	18.3	30	μA	FLASH=TORCH=5.5V
Low level Input current	IinL2	-2	-0.1	-	μA	FLASH=TORCH=0V
Other						
Input voltage range	Vin	3.1	-	5.5	V	VBAT input range
Quiescent Current	Iq	-	5	10	μA	Torch=Flash= OFF
Current Consumption	Idd1	-	1.8	2.5	μA	VFB=1.0V, VBAT=3.6V, Torch mode
Inductor current limit	Icoil	1.5	2.0	2.5	A	VBAT=3.6V
Switching frequency	fSW	480	600	720	kHz	
SW ON resistance	Ron	-	0.07	0.15	Ω	Iin=200mA
Duty cycle limit	Duty	60	65	-	%	VFB=0V
Output voltage range	Vo	-	-	5.4	V	
Over voltage limit	Ovl	5.4	5.5	5.6	V	VFB=0V
Start up time	Ts	-	0.5	1.0	ms	0mA to 200mA(Torch)
RTORCH terminal voltage 1	Vrt1	45	50	55	mV	Itorch[1:0]=00 (50mA)
RTORCH terminal voltage 2	Vrt2	90	100	110	mV	Itorch[1:0]=01 (100mA)
RTORCH terminal voltage 3	Vrt3	135	150	165	mV	Itorch[1:0]=10 (150mA)
RTORCH terminal voltage 4	Vrt4	180	200	220	mV	Itorch[1:0]=11 (200mA)
RFLASH terminal voltage 1	Vrf1	43	48	53	mV	Iflash[1:0]=00 (400mA)
RFLASH terminal voltage 2	Vrf2	54	60	66	mV	Iflash[1:0]=01 (500mA)
RFLASH terminal voltage 3	Vrf3	65	72	79	mV	Iflash[1:0]=10 (600mA)
RFLASH terminal voltage 4	Vrf4	86	96	106	mV	Iflash[1:0]=11 (800mA)

External dimensions

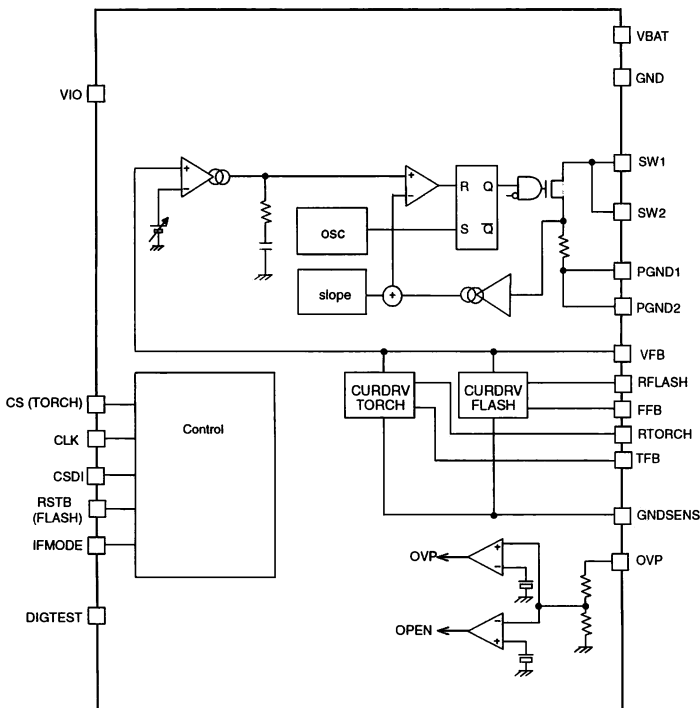


VCSP85H2 (23PIN) (Unit: mm)

Terminals

PIN	PIN Name	PIN	PIN Name
A1	TEST	C5	VIO
A2	RSTB/FLASH	D1	RTORCH
A3	FFB	D2	CS/TORCH
A4	GNDSENS	D3	OVP
A5	N.C	D4	PGND1
B1	RFLASH	D5	PGND2
B3	IFMODE	E1	N.C
B4	SW1	E2	GND
B5	SW2	E3	VBAT
C1	VFB	E4	CLK
C2	TFB	E5	N.C
C4	CSDI		

Block diagram



○Cautions on use

(1) Absolute Maximum Ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.

(2) Power supply and GND line

Design PCB pattern to provide low impedance for the wiring between the power supply and the GND lines. Pay attention to the interference by common impedance of layout pattern when there are plural power supplies and GND lines. Especially, when there are GND pattern for small signal and GND pattern for large current included the external circuits, please separate each GND pattern. Furthermore, for all power supply terminals to ICs, mount a capacitor between the power supply and the GND terminal. At the same time, in order to use a capacitor, thoroughly check to be sure the characteristics of the capacitor to be used present no problem including the occurrence of capacity dropout at a low temperature, thus determining the constant.

(3) GND voltage

Make setting of the potential of the GND terminal so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no terminals are at a potential lower than the GND voltage including an actual electric transient.

(4) Short circuit between terminals and erroneous mounting

In order to mount ICs on a set PCB, pay thorough attention to the direction and offset of the ICs. Erroneous mounting can break down the ICs. Furthermore, if a short circuit occurs due to foreign matters entering between terminals or between the terminal and the power supply or the GND terminal, the ICs can break down.

(5) Operation in strong electromagnetic field

Be noted that using ICs in the strong electromagnetic field can malfunction them.

(6) Input terminals

In terms of the construction of IC, parasitic elements are inevitably formed in relation to potential. The operation of the parasitic element can cause interference with circuit operation, thus resulting in a malfunction and then breakdown of the input terminal. Therefore, pay thorough attention not to handle the input terminals, such as to apply to the input terminals a voltage lower than the GND respectively, so that any parasitic element will operate. Furthermore, do not apply a voltage to the input terminals when no power supply voltage is applied to the IC. In addition, even if the power supply voltage is applied, apply to the input terminals a voltage lower than the power supply voltage or within the guaranteed value of electrical characteristics.

(7) External capacitor

In order to use a ceramic capacitor as the external capacitor, determine the constant with consideration given to a degradation in the nominal capacitance due to DC bias and changes in the capacitance due to temperature, etc.

(8) Thermal shutdown circuit (TSD)

This LSI builds in a thermal shutdown (TSD) circuit. When junction temperatures become detection temperature or higher, the thermal shutdown circuit operates and turns a switch OFF. The thermal shutdown circuit, which is aimed at isolating the LSI from thermal runaway as much as possible, is not aimed at the protection or guarantee of the LSI. Therefore, do not continuously use the LSI with this circuit operating or use the LSI assuming its operation.

(9) Thermal design

Perform thermal design in which there are adequate margins by taking into account the permissible dissipation (Pd) in actual states of use.

(10) DC/DC converter

Please select the low DCR inductors to decrease power loss for DC/DC converter.

(11) Other cautions on use

Please consult supplementary documents such as technical notebook, function manual and application design guide of this LSI.

Notes

- No technical content pages of this document may be reproduced in any form or transmitted by any means without prior permission of ROHM CO.,LTD.
- The contents described herein are subject to change without notice. The specifications for the product described in this document are for reference only. Upon actual use, therefore, please request that specifications to be separately delivered.
- Application circuit diagrams and circuit constants contained herein are shown as examples of standard use and operation. Please pay careful attention to the peripheral conditions when designing circuits and deciding upon circuit constants in the set.
- Any data, including, but not limited to application circuit diagrams information, described herein are intended only as illustrations of such devices and not as the specifications for such devices. ROHM CO.,LTD. disclaims any warranty that any use of such devices shall be free from infringement of any third party's intellectual property rights or other proprietary rights, and further, assumes no liability of whatsoever nature in the event of any such infringement, or arising from or connected with or related to the use of such devices.
- Upon the sale of any such devices, other than for buyer's right to use such devices itself, resell or otherwise dispose of the same, no express or implied right or license to practice or commercially exploit any intellectual property rights or other proprietary rights owned or controlled by
- ROHM CO., LTD. is granted to any such buyer.
- Products listed in this document are no antiradiation design.

The products listed in this document are designed to be used with ordinary electronic equipment or devices (such as audio visual equipment, office-automation equipment, communications devices, electrical appliances and electronic toys).

Should you intend to use these products with equipment or devices which require an extremely high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.

It is our top priority to supply products with the utmost quality and reliability. However, there is always a chance of failure due to unexpected factors. Therefore, please take into account the derating characteristics and allow for sufficient safety features, such as extra margin, anti-flammability, and fail-safe measures when designing in order to prevent possible accidents that may result in bodily harm or fire caused by component failure. ROHM cannot be held responsible for any damages arising from the use of the products under conditions out of the range of the specifications or due to non-compliance with the NOTES specified in this catalog.

Thank you for your accessing to ROHM product informations.

More detail product informations and catalogs are available, please contact your nearest sales office.

ROHM Customer Support System

THE AMERICAS / EUROPE / ASIA / JAPAN

www.rohm.com

Contact us : webmaster@rohm.co.jp